

CRYSTAL SPECIFICATION

Manufacturer:

ECS Inc. International

Manufacturer P/N: ECS-320-CDX-2374

Customer:

Customer P/N:

Customer Approval :

ECS Inc. International Tel: (913)-782-7787 Fax: (913)-782-6991 Website: www.ecsxtal.com Sales: sales@ecsxtal.com Engineering: engineering@ecsxtal.com Date: 02-21-2023 Approved By: B. Slatten

Checked By: D. Kelly

Designer: A. Anderson



Rev.	Description of Revision History	Date	Designer	Checked By
1	New Publication	02-21-2023	A. Anderson	By D. Kelly



CRYSTAL SPECIFICATION

1.	Description	:	Quartz Crystal
2.	Nominal Frequency	:	32.0000000 MHz
3.	Center Frequency	:	32.0000000 MHz
4.	Dimension & Drawing No.	:	ECX-1048B
5.	Oscillation Mode	:	Fundamental
6.	Cutting Mode	:	AT cut
7.	Packing Style	:	Tape & Reel
8.	Measurement Instrument	:	S&A 250B (Measured FL)
9.	Electrical Characteristics	:	

9. Electrical Characteristics [1] Operating Conditions:

Item	Symbol	MIN.	TYP.	MAX.	Unit	Condition
Operating Temperature Range	Topt	-20		70	°C	
Storage Temperature Range	Tstg	-40		105	°C	
Load Capacitance	CL		8		pF	
Drive Level	DL		50	200	μW	

[2] Frequency Stability:

Item	Symbol	MIN.	TYP.	MAX.	Unit	Condition
Tolerance	dF/Fo	-10		10	ppm	Refer to Center Frequency @25±3°C
Stability Over Temperature	dF/F25	-10		10	ppm	Refer to Operating Temperature
Aging	dF/F25	-2		2	ppm	First Year

dF/Fo: Frequency Deviation Refer to Center Frequency

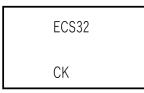
dF/F25: Frequency Deviation Refer to 25 $^\circ\text{C}$ Frequency



[3] Electrical Performance :

Item	Symbol	MIN.	TYP.	MAX.	Unit	Condition
Equivalent Series Resistance	ESR			80	Ω	@Series
Shunt Capacitance	C0			3	pF	
Insulation Resistance	IR	500			MΩ	@DC 100 Volt

10. Marking : Laser



11. Remark :

*Compliant with EU RoHS 2015/863 * MSL 1

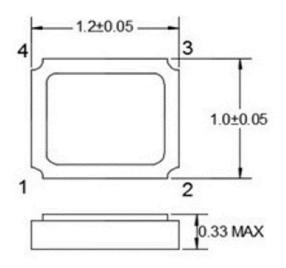
∎Note

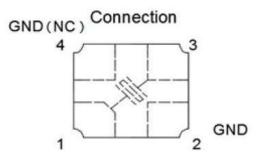
1. General cleaning solutions or ultrasonic cleaning method may be used to clean our products. However, under certain circumstances, ultrasonic cleaning machine could generate resonance at the oscillation frequency of our products and thus deteriorate the electrical characteristics in devices, and even damage the overall structure of devices. Therefore, verification test is recommended before cleaning.

2. Avoid mounting and processing by Ultrasonic welding this method has a possibility of an excessive vibration spreading inside the crystal products and becoming the cause of characteristic deterioration and not oscillating.

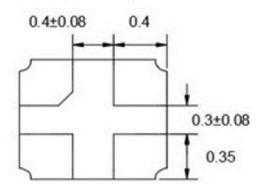


Dimensions: Top, Side and Bottom View Unit: mm



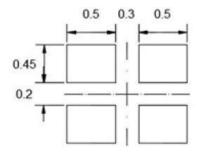






PAD CONNECTIONS				
1	In/Out			
2	Gnd & Lid			
3	Out/In			
4	NC/Gnd			

Land Pattern: (Reference)





RELIABILITY SPECIFICATION

1. ENVIRONMENTAL PERFORMANCE

ITEM	0	CONDITION				
1. HIGH TEMPERATURE	STORED AT 85±2°C FOR 1000±12H. (If Customer's temperature request is					
STORAGE	higher than the standard, Temperature test must be done for customer					
	requirements.)					
	THEN 25±2°C OVER 2H BEFORE TESTING.					
2. LOW TEMPERATURE	STORED AT -40±2°C FOR 500=	±12H. (If Customer's temperature request is				
STORAGE		ture test must be done for customer				
	requirements.)					
	THEN 25±2°C OVER 2H BEFOR	RE TESTING.				
3. HIGH TEMP. & HUMIDITY	STORED AT $60 \pm 2^{\circ}$ C AND HUMIDITY $90 \sim 95\%$ FOR 500 ± 12 H.					
	THEN 25±2°C OVER 2H BEFOR	RE TESTING.				
4. TEMPERATURE CYCLE	THE CRYSTAL UNIT SHALL BE SUBJECTED TO 1000 SUCCESSIVE					
	CHANGE OF TEMPERATURE CYCLES, THEN 25 $\pm 2^{\circ}$ C OVER 2 H					
	BEFORE TESTING, EACH CYCLE AS BELLOW :					
	TEMPERATURE	DURATION				
	140+0/-6°C	30 ± 3 MINUTES				
	$2.25^{\circ}C \pm 2^{\circ}C$	2~3 MINUTES				
	3. 125+4/-0°C	30 ±3 MINUTES				
	$4.25^{\circ}C \pm 2^{\circ}C$	2~3 MINUTES				

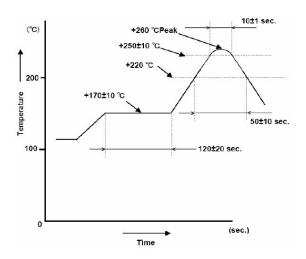
2. MECHANICAL PERFORMANCE

CONDITION
THE LEAD IS IMMERSED IN A 260 \pm 5°C SOLDER BATH WITHIN
2±0.6 SECONDS.
REFLOW CHART AS ATTACH SHEET. TWICE PASS.
FREE DROPPING FROM 75 cm HEIGHT 3 TIMES ON A HARD
WOODEN BOARD.
FREQUENCY : 10~55Hz,
AMPLITUDE (TOTAL EXCURSION) : 1.5 mm \pm 15%,
SWEEP TIME : 1MIN, 3 DIRECTION(X, Y, Z) EACH FOR 2 Hrs.
STANDARD SAMPLE FOR AUTOMATIC GROSS LEAK DETECTOR,
TEST PRESSURE: 0.2 Mpa
HELIUM BOMBING 5.0~5.5 Kgf / cm ²
FOR 2 HOURS.



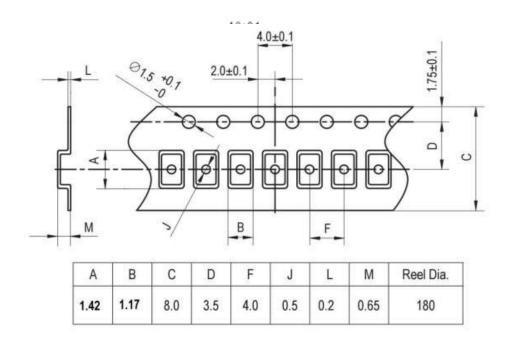
11. TERMINAL STRENGTH	SHALL BE PRESSURIZED AT A SPEED OF APPROX.0.5mm/sec IN THE DIRECTION INDICATED BY THE ARROW UNTIL THE BENDING WIDTH REACHES 3mm AND HELD FOR 5 SECONDS.
12. STICKING TENDENCY	A R0.5 JIG SHALL BE USED TO APPLY A 10N DEAD LOAD IN THE DIRECTION INDICATED BY THE ARROW TO THE ELEMENT AND RETAIN IT FOR 10 SECONDS.
13. ELEMENT ASSEMBLY STRENGTH	A R0.5 PRESSURIZED BAR SHALL BE USED TO APPLY A 10N LOAD IN THE CENTER OF ELEMENT AND RETAIN IT FOR 10 SECONDS.

► SUGGESTED REFLOW PROFILE





PACKING
Unit: mm
1. CARRIER TYPE



X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for Crystals category:

Click to view products by ECS Inc manufacturer:

Other Similar products are found below :

CX3225GB25000M0PPSZ1 718-13.2-1 7A-40.000MAAE-T FL200085 99-BU 9B-15.360MBBK-B 9C-7.680MBBK-T H10S-12.000-18-EXT-TR ABC2-6.000MHZ-D4Z-T ABLS-20.000MHZ-D2-T ABM3B-27.000MHZ-D4Y-T ABS071-32.768KHZ-6-T R38-32.768-12.5-5PPM-NPB BTD1062E05A-513 C711980XFAS30XX 21U15A-21.4MHZ RTX-781DF1-S-20.950 LFXTAL066198Cutt 9C-14.31818MBBK-T A-11.000MHZ-27 ABL-27.000MHZ-B4Y-T ABM11-132-24.000MHZ-T3 ABM3B1-25.000MHZ-D2Y-T SPT2A-.032768B SPT2A.032768G SSPT7F-9PF20-R LFXTAL065253Cutt LFXTAL066431Cutt XT9S20ANA14M7456 XT9SNLANA16M 7A-24.576MBBK-T 7B-30.000MBBK-T CX2520DB16000H0HPQCC MMCC2R32.7680KHZ 7A-14.31818MBBK-T 6504-202-1501 6526-202-1501 ABLS-12.000MHZ-B2Y-T 7A-10.000MBBK-T SG636PCE-20.000MC 3404 CM315D32768EZFT C1E-24.000-7-2020-R C1E-19.200-12-1530-X-R C1E-16.000-12-1530-X-R ABM11-16.000MHZ-9-B1U-T FL5000014 EUCA18-3.1872M FX0800015 425F35E027M0000